

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LEI ZHOU	01/03/2019
DANDAN ZHANG	01/02/2019
LVHAI HU	01/02/2019
YUN LIU	01/02/2019
ROBERTO FRANCISCO-YI LU	01/16/2019

RECEIVING PARTY DATA

Name:	TYCO ELECTRONICS (SHANGHAI) CO. LTD.
Street Address:	SECTIONS F & G, LEVEL 1, BUILDING 15, NO. 999 YINGLUN RD.
Internal Address:	CHINA (SHANGHAI) PILOT FREE TRADE ZONE
City:	SHANGHAI
State/Country:	CHINA
Name:	TE CONNECTIVITY CORPORATION
Street Address:	1050 WESTLAKES DRIVE
City:	BERWYN
State/Country:	PENNSYLVANIA
Postal Code:	19312

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16270971

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	21334-2750
NAME OF SUBMITTER:	SALVATORE ANASTASI
SIGNATURE:	/Salvatore Anastasi/
DATE SIGNED:	02/08/2019
Total Attachments: 4 source=DeclAssn1#page1.tif source=DeclAssn1#page2.tif source=DeclAssn2#page1.tif source=DeclAssn2#page2.tif	

Attorney Docket No.: 21334-2750

COMBINED DECLARATION AND ASSIGNMENT

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
- United States application or PCT international application number _____
filed on _____, entitled Imaging Apparatus ("the APPLICATION")

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

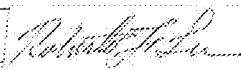
I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

Tyco Electronics (Shanghai) Co. Ltd. and TE Connectivity Corporation ("ASSIGNEE"), corporations organized and existing under and by virtue of the laws of **China and The United States** having their principal place of business at **Sections F and G Level 1 Building 15 No. 999 Yinglun Road, China (Shanghai) Pilot Free Trade Zone, Shanghai, China and 1050 Westlakes Drive Berwyn, Pennsylvania, 19312 United States**,

for a valuable consideration, the receipt of which is hereby acknowledged, **I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns**, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
ZHOU, Lei		
ZHANG, Dandan		
LU, Roberto Francisco-Yi		2019.1.16
HU, Lvhai		

US -- United States

IP Portal

24-Jan-2019

Our Ref.: P198943.US.01

Client Ref.: TE-00184 US

LIU, Yun		
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Attorney Docket No.: 21334-2750

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- the attached application, or
- United States application or PCT international application number _____
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I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

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Legal Name	Signature	Date
ZHOU, Lei	<i>Zhou Lei</i>	2019/1/3
ZHANG, Dandan	<i>Dandan Zhang</i>	2019/1/2
LU, Roberto Francisco-Yi		
HU, Lvhai	<i>Hu Lvhai</i>	2019/1/2

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Our Ref.: P198943.US.01

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LIU, Yun	刘云	2019. 1. 2
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